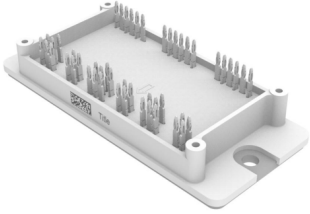
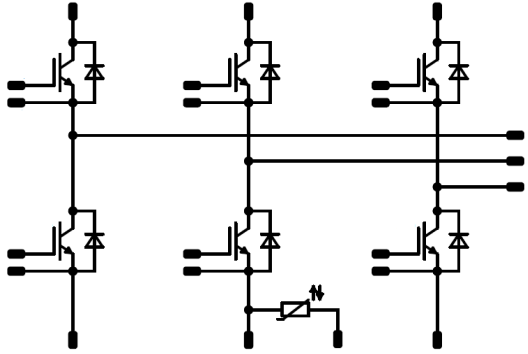




Vincotech

<i>flow</i> PACK 2	1200 V / 150 A
<div style="border: 1px solid black; padding: 5px; margin-bottom: 5px;"> <p style="text-align: center; background-color: #cccccc; margin: 0;">Features</p> <ul style="list-style-type: none"> IGBT4 (1200V) technology for low saturation losses and improved EMC behavior Compact and low inductive design Integrated temperature sensor </div> <div style="border: 1px solid black; padding: 5px; margin-bottom: 5px;"> <p style="text-align: center; background-color: #cccccc; margin: 0;">Target applications</p> <ul style="list-style-type: none"> Industrial Drives </div> <div style="border: 1px solid black; padding: 5px;"> <p style="text-align: center; background-color: #cccccc; margin: 0;">Types</p> <ul style="list-style-type: none"> 30-P2126PA150SC-L280F09Y </div>	<div style="border: 1px solid black; padding: 5px; margin-bottom: 5px;"> <p style="text-align: center; background-color: #cccccc; margin: 0;"><i>flow</i> 2 17mm housing</p>  </div> <div style="border: 1px solid black; padding: 5px;"> <p style="text-align: center; background-color: #cccccc; margin: 0;">Schematic</p>  </div>

Maximum Ratings

$T_j = 25\text{ °C}$, unless otherwise specified

Parameter	Symbol	Condition	Value	Unit
Inverter Switch				
Collector-emitter voltage	V_{CES}		1200	V
Collector current	I_C	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	144	A
Repetitive peak collector current	I_{CRM}	t_p limited by T_{jmax}	450	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	354	W
Gate-emitter voltage	V_{GES}		±20	V
Short circuit ratings	t_{SC} V_{CC}	$T_j \leq 150\text{ °C}$ $V_{GE} = 15V$	10 800	µs V
Maximum Junction Temperature	T_{jmax}		175	°C



Vincotech

Parameter	Symbol	Condition	Value	Unit
Inverter Diode				
Peak Repetitive Reverse Voltage	V_{RRM}		1200	V
Continuous (direct) forward current	I_F	$T_J = T_{jmax}$ $T_s = 80^\circ\text{C}$	122	A
Repetitive peak forward current	I_{FRM}		300	A
Total power dissipation	P_{tot}	$T_J = T_{jmax}$ $T_s = 80^\circ\text{C}$	212	W
Maximum Junction Temperature	T_{jmax}		175	$^\circ\text{C}$

Module Properties

Thermal Properties

Storage temperature	T_{stg}		-40...+125	$^\circ\text{C}$
Operation temperature under switching condition	T_{jop}		-40...+($T_{jmax} - 25$)	$^\circ\text{C}$

Isolation Properties

Isolation voltage	V_{isol}	DC Voltage $t_p = 2s$	4000	V
Creepage distance			min. 12,7	mm
Clearance			min. 12,7	mm
Comparative Tracking Index	CTI		> 200	



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Characteristic Values

Parameter	Symbol	Conditions					Value			Unit
		V_{GE} [V] V_{GS} [V]	V_{CE} [V] V_{GS} [V] V_r [V]	I_C [A] I_D [A] I_F [A]	T_j [°C]	Min	Typ	Max		

Inverter Switch

Static

Gate-emitter threshold voltage	$V_{GE(th)}$	$V_{GE}=V_{CE}$			0,0052	25	5,3	5,8	6,3	V
Collector-emitter saturation voltage	V_{CEsat}		15		150	25 150	1,58	1,93 2,39	2,07	V
Collector-emitter cut-off current	I_{CES}		0	1200		25			2	μA
Gate-emitter leakage current	I_{GES}		20	0		25			240	nA
Internal gate resistance	r_g							5		Ω
Input capacitance	C_{ies}	f=1 MHz	0	25		25		8600		pF
Reverse transfer capacitance	C_{res}							320		

Thermal

Thermal resistance junction to sink	$R_{th(j-s)}$	phase-change material $\lambda = 3,4$ W/mK						0,27		K/W
-------------------------------------	---------------	--	--	--	--	--	--	------	--	-----

IGBT Switching

Turn-on delay time	$t_{d(on)}$	$R_{goff} = 4 \Omega$ $R_{gon} = 4 \Omega$	±15	600	150	25		213		ns
Rise time	t_r					150		229		
Turn-off delay time	$t_{d(off)}$					25		35		
Fall time	t_f					150		44		
Turn-on energy (per pulse)	E_{on}	$Q_{rFWD} = 15,6 \mu C$ $Q_{rFWD} = 29,2 \mu C$				25		12,684		mWs
Turn-off energy (per pulse)	E_{off}					150		18,795		
						25		8,071		
						150		12,853		



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Characteristic Values

Parameter	Symbol	Conditions					Value			Unit
		V_{GE} [V] V_{GS} [V]	V_{CE} [V] V_{GS} [V] V_r [V]	I_C [A] I_D [A] I_F [A]	T_j [°C]	Min	Typ	Max		

Inverter Diode

Static

Forward voltage	V_F				150	25 150		1,91 1,91	2,05	V
Reverse leakage current	I_r			1200		25			26	μ A

Thermal

Thermal resistance junction to sink	$R_{th(j-s)}$	phase-change material $\lambda = 3,4$ W/mK						0,45		K/W
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FWD Switching

Peak recovery current	I_{RRM}	$di/dt = 4656$ A/ μ s $di/dt = 4044$ A/ μ s	± 15	600	150	25		143		A
Reverse recovery time	t_{rr}					150		168		ns
						25		287		
Recovered charge	Q_r					150		29,157		μ C
Reverse recovered energy	E_{rec}					25		5,706		mWs
		150		10,813						
Peak rate of fall of recovery current	$(di_{rr}/dt)_{max}$						3267 1615		A/ μ s	

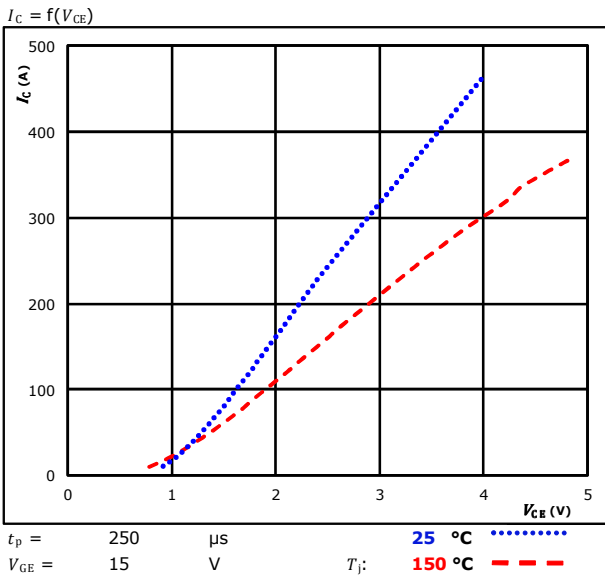
Thermistor

Rated resistance	R					25		22		k Ω
Deviation of R100	$\Delta_{R/R}$	R100=1486 Ω				100	-12		+14	%
Power dissipation	P					25		200		mW
Power dissipation constant						25		2		mW/K
B-value	$B_{(25/50)}$	Tol. $\pm 3\%$				25		3950		K
B-value	$B_{(25/100)}$	Tol. $\pm 3\%$				25		3998		K
Vincotech NTC Reference									B	

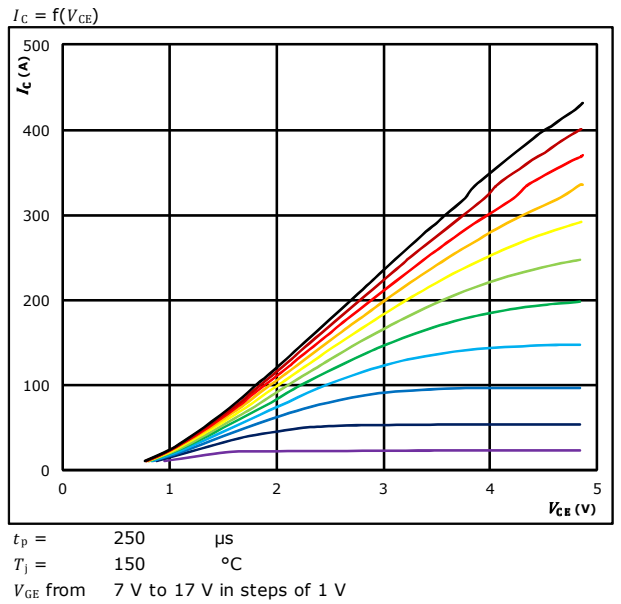


Inverter Switch Characteristics

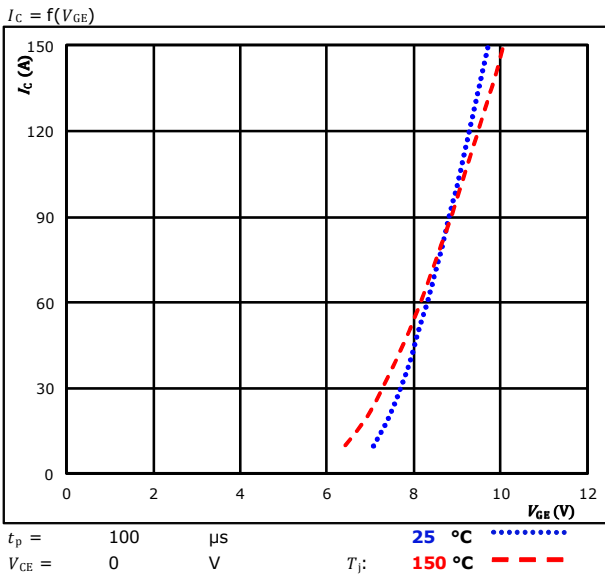
Typical output characteristics IGBT



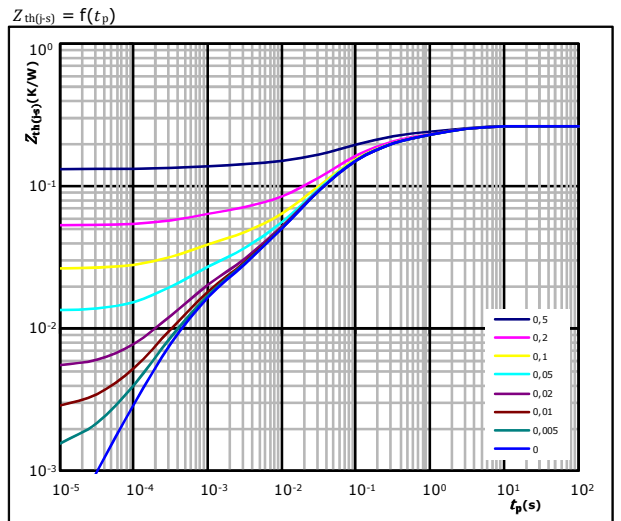
Typical output characteristics IGBT



Typical transfer characteristics IGBT



Transient Thermal Impedance as function of Pulse duration IGBT



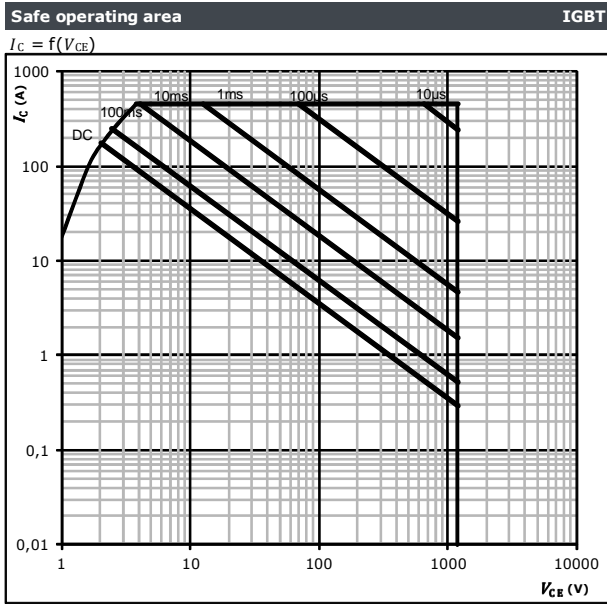
$D = \frac{t_p}{T}$
 $R_{th(j-s)} = 0,27 \text{ K/W}$
 IGBT thermal model values

R (K/W)	τ (s)
5,73E-02	1,79E+00
6,23E-02	2,33E-01
9,18E-02	6,24E-02
3,46E-02	2,03E-02
1,02E-02	2,96E-03
1,19E-02	4,61E-04



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Inverter Switch Characteristics



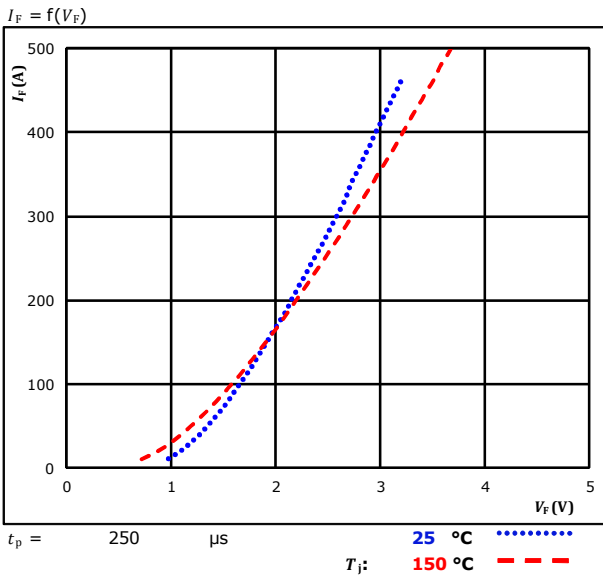
At

- $D =$ single pulse
- $T_s =$ 80 °C
- $V_{GE} =$ ± 15 V
- $T_j = T_{jmax}$ °C

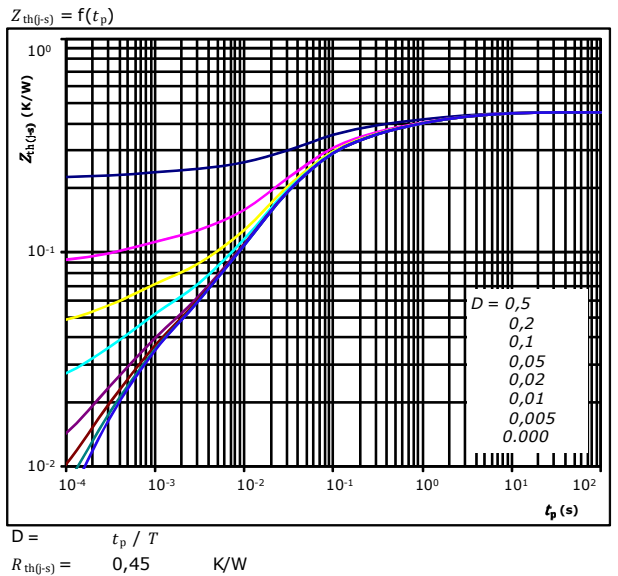


Inverter Diode Characteristics

Typical forward characteristics FWD



Transient thermal impedance as a function of pulse width FWD



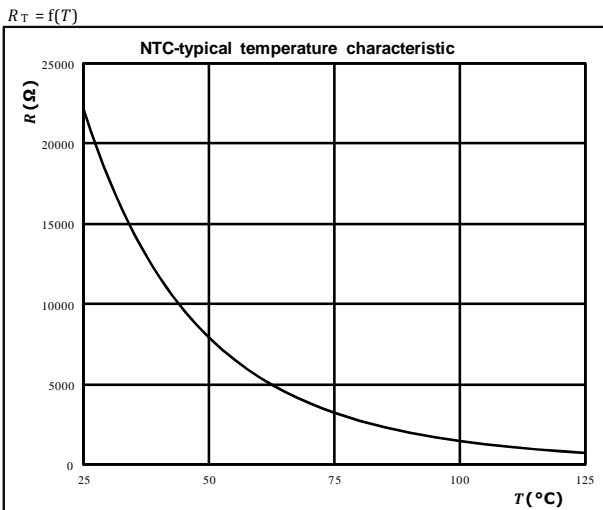
FWD thermal model values

R (K/W)	τ (s)
3,4710E-02	4,6050E+00
6,6830E-02	8,7990E-01
9,3970E-02	1,7000E-01
1,6240E-01	4,0270E-02
5,3480E-02	1,3400E-02
1,5680E-02	2,0050E-03
2,1540E-02	4,0000E-04

Thermistor Characteristics

Thermistor typical temperature characteristic

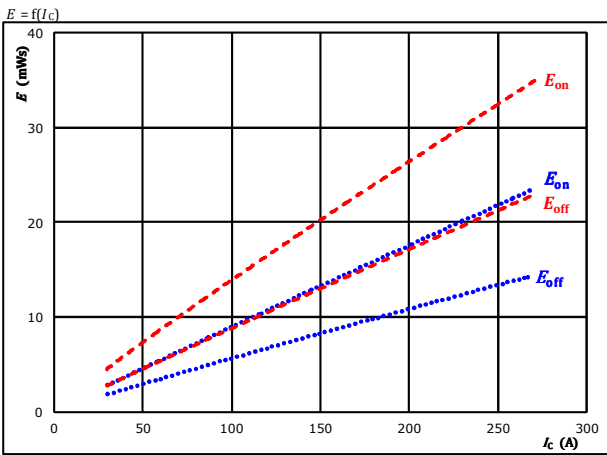
Typical NTC characteristic as a function of temperature





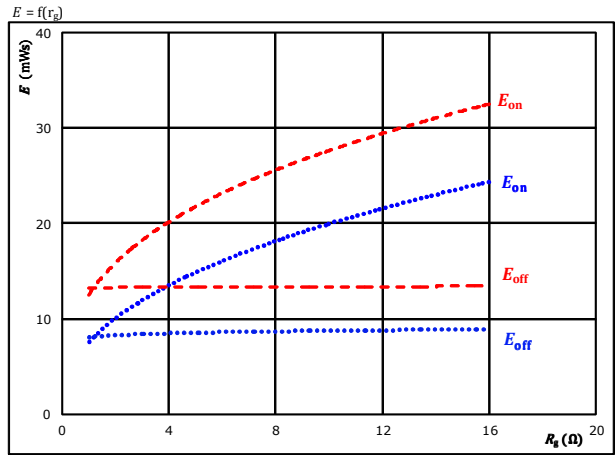
Inverter Switching Characteristics

Figure 1. IGBT
Typical switching energy losses as a function of collector current



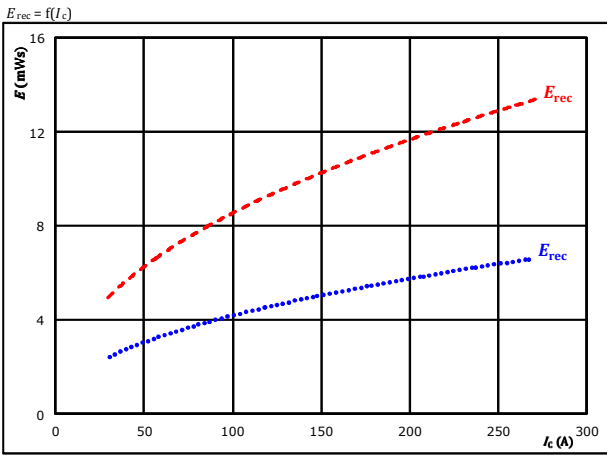
With an inductive load at
 $V_{CE} = 600$ V
 $V_{GE} = \pm 15$ V
 $R_{gon} = 4$ Ω
 $R_{goff} = 4$ Ω
 $T_j: 25$ °C (blue dotted line)
 150 °C (red dashed line)

Figure 2. IGBT
Typical switching energy losses as a function of gate resistor



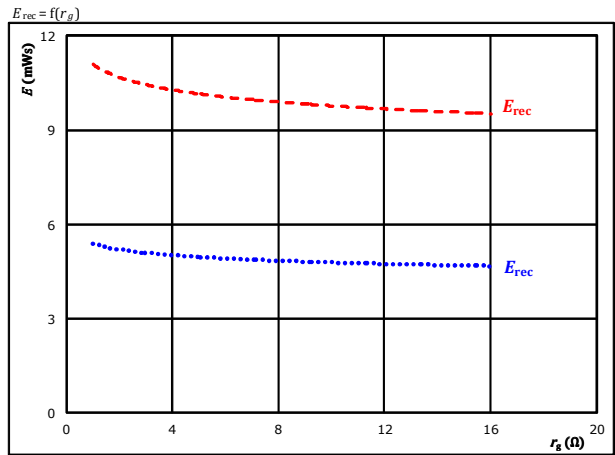
With an inductive load at
 $V_{CE} = 600$ V
 $V_{GE} = \pm 15$ V
 $I_C = 150$ A
 $T_j: 25$ °C (blue dotted line)
 150 °C (red dashed line)

Figure 3. FWD
Typical reverse recovered energy loss as a function of collector current



With an inductive load at
 $V_{CE} = 600$ V
 $V_{GE} = \pm 15$ V
 $R_{gon} = 4$ Ω
 $T_j: 25$ °C (blue dotted line)
 150 °C (red dashed line)

Figure 4. FWD
Typical reverse recovered energy loss as a function of gate resistor



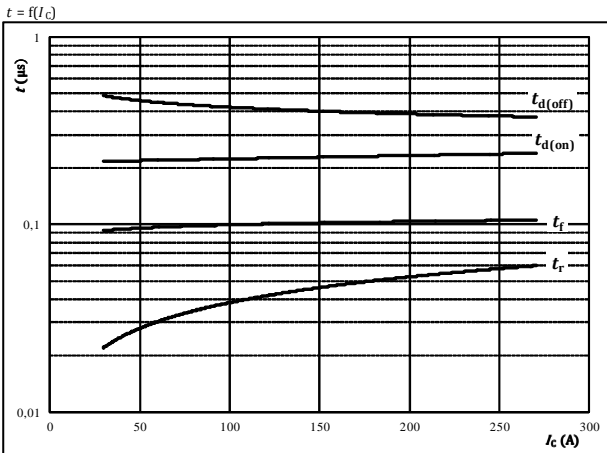
With an inductive load at
 $V_{CE} = 600$ V
 $V_{GE} = \pm 15$ V
 $I_C = 150$ A
 $T_j: 25$ °C (blue dotted line)
 150 °C (red dashed line)



Inverter Switching Characteristics

Figure 5. IGBT

Typical switching times as a function of collector current

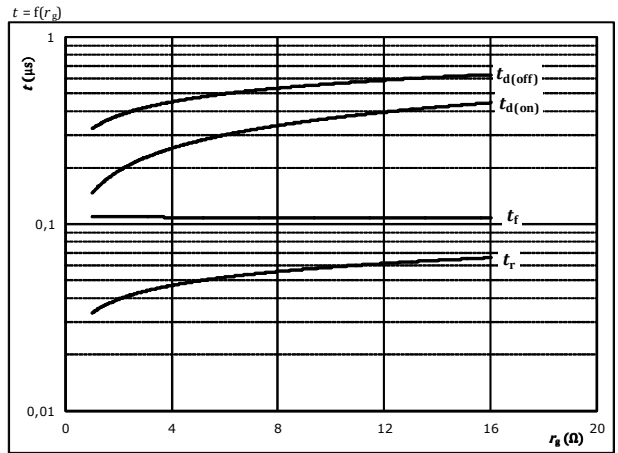


With an inductive load at

$T_j =$	150	°C
$V_{CE} =$	600	V
$V_{GE} =$	±15	V
$R_{gon} =$	4	Ω
$R_{goff} =$	4	Ω

Figure 6. IGBT

Typical switching times as a function of gate resistor

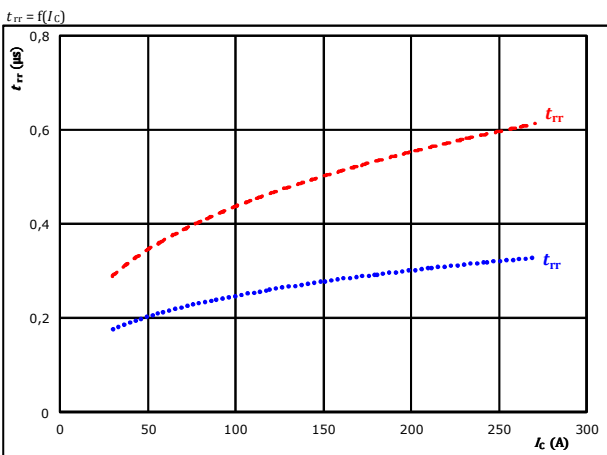


With an inductive load at

$T_j =$	150	°C
$V_{CE} =$	600	V
$V_{GE} =$	±15	V
$I_C =$	150	A

Figure 7. FWD

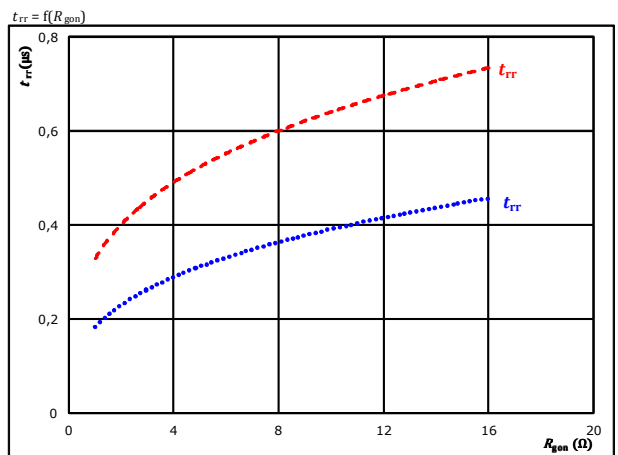
Typical reverse recovery time as a function of collector current



At	$V_{CE} =$	600	V	$T_j:$	25 °C
	$V_{GE} =$	±15	V		150 °C	-----
	$R_{gon} =$	4	Ω			

Figure 8. FWD

Typical reverse recovery time as a function of IGBT turn on gate resistor

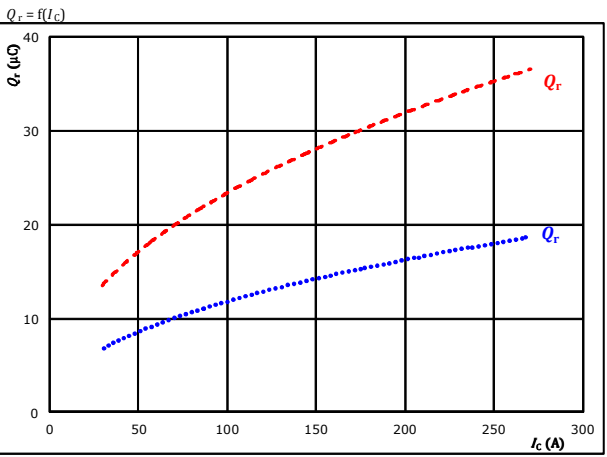


At	$V_{CE} =$	600	V	$T_j:$	25 °C
	$V_{GE} =$	±15	V		150 °C	-----
	$I_C =$	150	A			



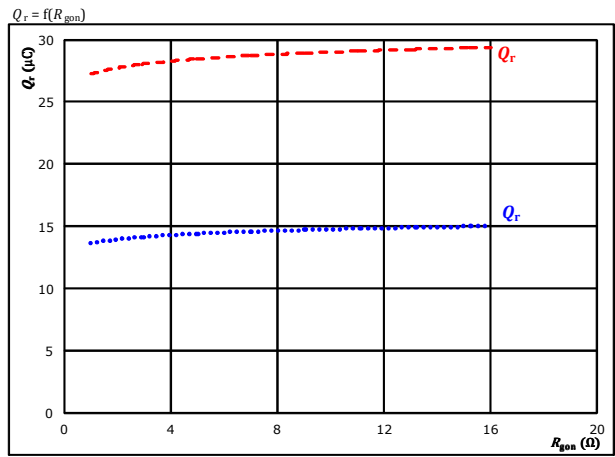
Inverter Switching Characteristics

Figure 9. FWD
Typical recovered charge as a function of collector current



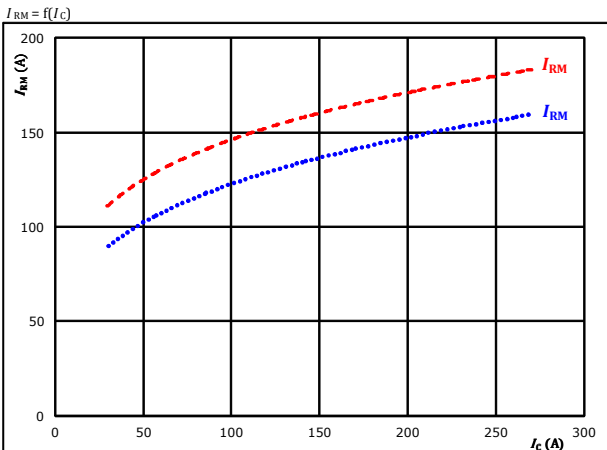
At $V_{CE} = 600$ V
 $V_{GE} = \pm 15$ V
 $R_{gon} = 4$ Ω
 $T_j: 25$ °C (blue dotted line)
 150 °C (red dashed line)

Figure 10. FWD
Typical recovered charge as a function of IGBT turn on gate resistor



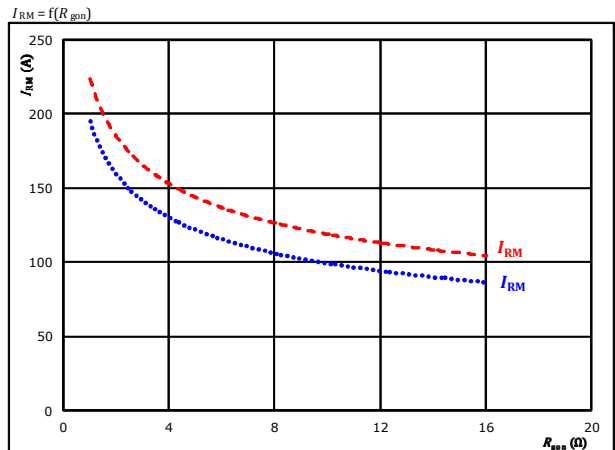
At $V_{CE} = 600$ V
 $V_{GE} = \pm 15$ V
 $I_c = 150$ A
 $T_j: 25$ °C (blue dotted line)
 150 °C (red dashed line)

Figure 11. FWD
Typical peak reverse recovery current as a function of collector current



At $V_{CE} = 600$ V
 $V_{GE} = \pm 15$ V
 $R_{gon} = 4$ Ω
 $T_j: 25$ °C (blue dotted line)
 150 °C (red dashed line)

Figure 12. FWD
Typical peak reverse recovery current as a function of IGBT turn on gate resistor



At $V_{CE} = 600$ V
 $V_{GE} = \pm 15$ V
 $I_c = 150$ A
 $T_j: 25$ °C (blue dotted line)
 150 °C (red dashed line)

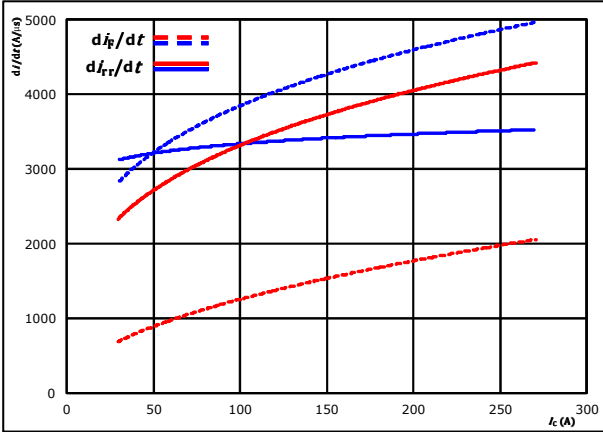


Inverter Switching Characteristics

Figure 13. FWD

Typical rate of fall of forward and reverse recovery current as a function of collector current

$$di_F/dt, di_{rr}/dt = f(I_C)$$

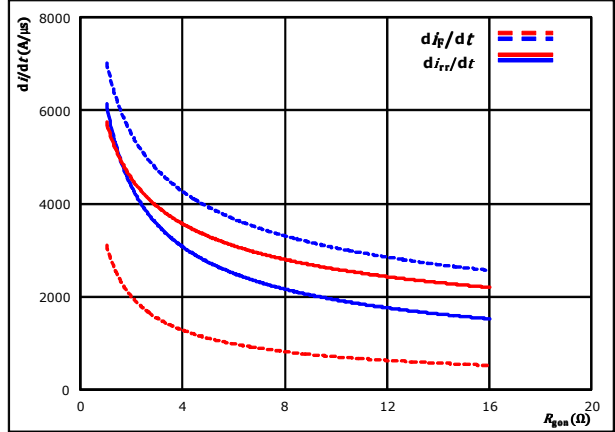


At $V_{CE} = 600$ V
 $V_{GE} = \pm 15$ V
 $R_{gon} = 4$ Ω
 $T_j = 25$ °C (dotted lines)
 150 °C (dashed lines)

Figure 14. FWD

Typical rate of fall of forward and reverse recovery current as a function of IGBT turn on gate resistor

$$di_F/dt, di_{rr}/dt = f(R_g)$$

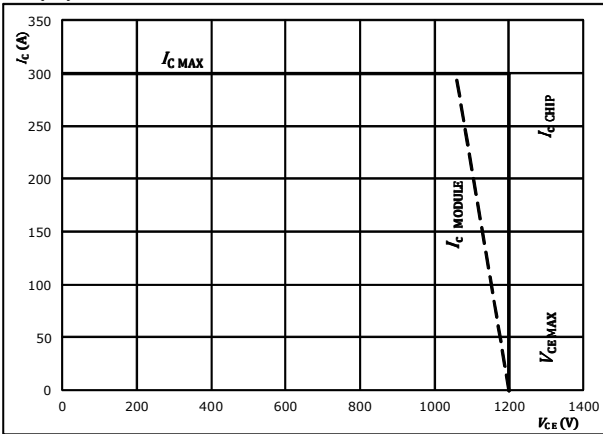


At $V_{CE} = 600$ V
 $V_{GE} = \pm 15$ V
 $I_C = 150$ A
 $T_j = 25$ °C (dotted lines)
 150 °C (dashed lines)

Figure 15. IGBT

Reverse bias safe operating area

$$I_C = f(V_{CE})$$



At $T_j = 175$ °C
 $R_{gon} = 4$ Ω
 $R_{goff} = 4$ Ω

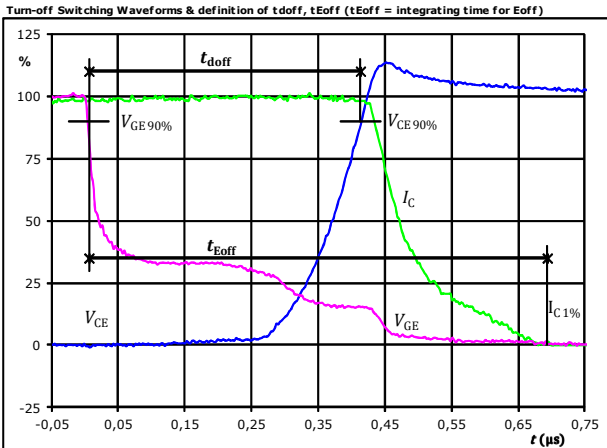


Inverter Switching Definitions

General conditions

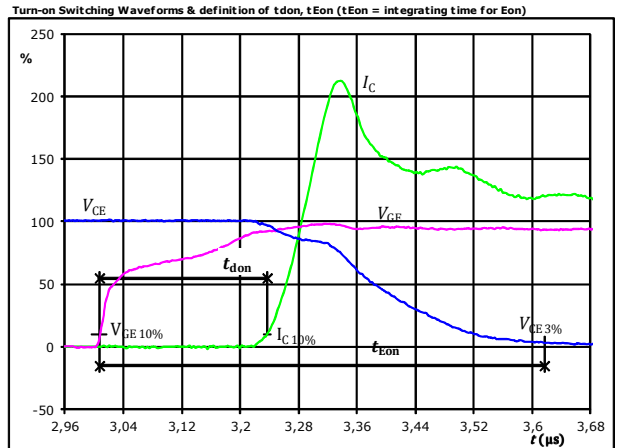
T_j	=	150 °C
R_{gon}	=	4 Ω
R_{goff}	=	4 Ω

Figure 1. IGBT



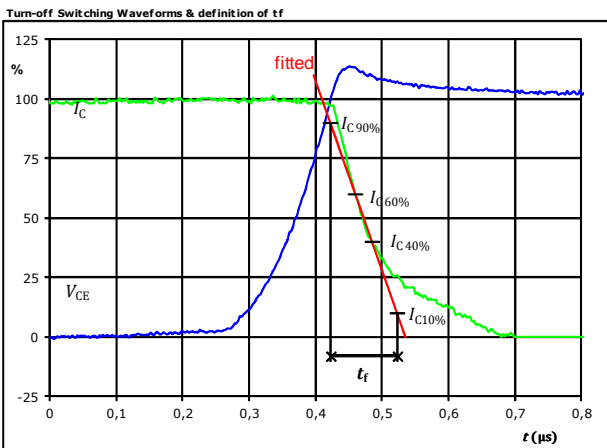
$V_{GE}(0\%) =$	-15	V
$V_{GE}(100\%) =$	15	V
$V_C(100\%) =$	600	V
$I_C(100\%) =$	149	A
$t_{doff} =$	0,410	μs
$t_{Eoff} =$	0,687	μs

Figure 2. IGBT



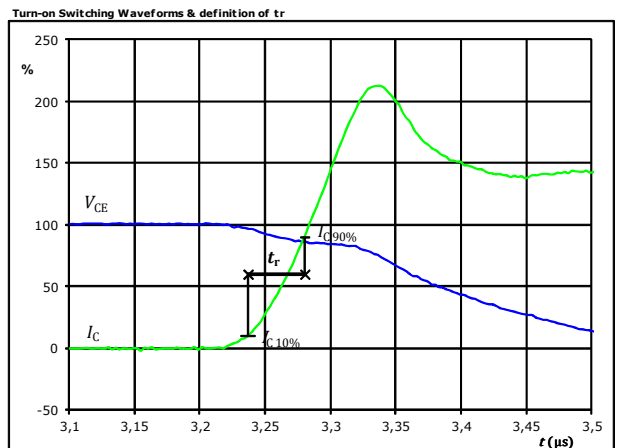
$V_{GE}(0\%) =$	-15	V
$V_{GE}(100\%) =$	15	V
$V_C(100\%) =$	600	V
$I_C(100\%) =$	149	A
$t_{don} =$	0,229	μs
$t_{Eon} =$	0,609	μs

Figure 3. IGBT



$V_C(100\%) =$	600	V
$I_C(100\%) =$	149	A
$t_f =$	0,104	μs

Figure 4. IGBT

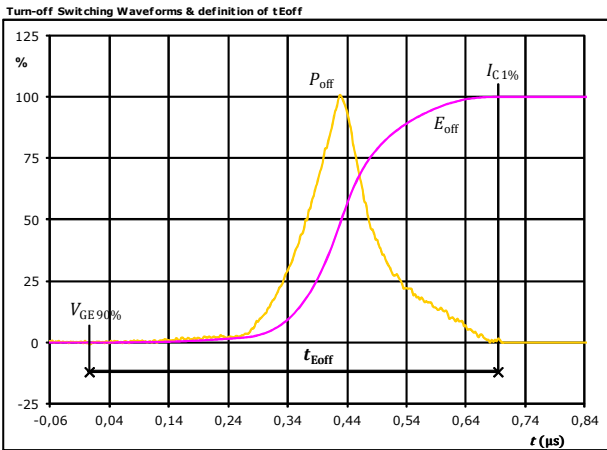


$V_C(100\%) =$	600	V
$I_C(100\%) =$	149	A
$t_r =$	0,044	μs



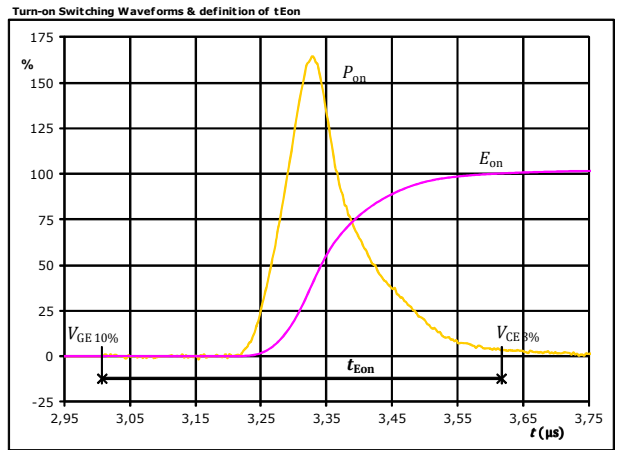
Inverter Switching Definitions

Figure 5. IGBT



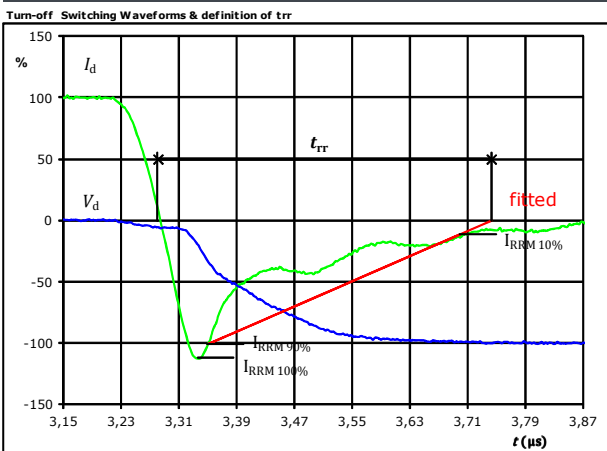
$P_{off}(100\%) =$	89,53	kW
$E_{off}(100\%) =$	12,85	mJ
$t_{Eoff} =$	0,69	μs

Figure 6. IGBT



$P_{on}(100\%) =$	89,53	kW
$E_{on}(100\%) =$	18,80	mJ
$t_{Eon} =$	0,61	μs

Figure 7. FWD



$V_d(100\%) =$	600	V
$I_d(100\%) =$	149	A
$I_{RRM}(100\%) =$	-168	A
$t_{rr} =$	0,465	μs



Inverter Switching Definitions

Figure 8. FWD

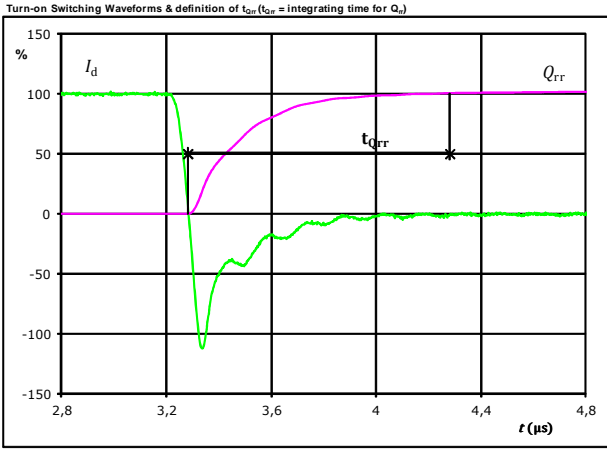
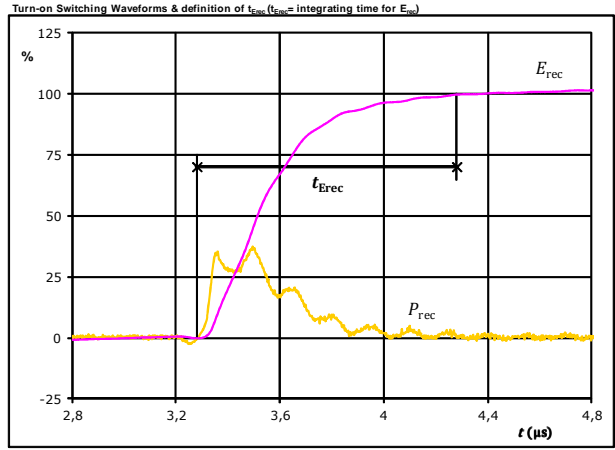


Figure 9. FWD





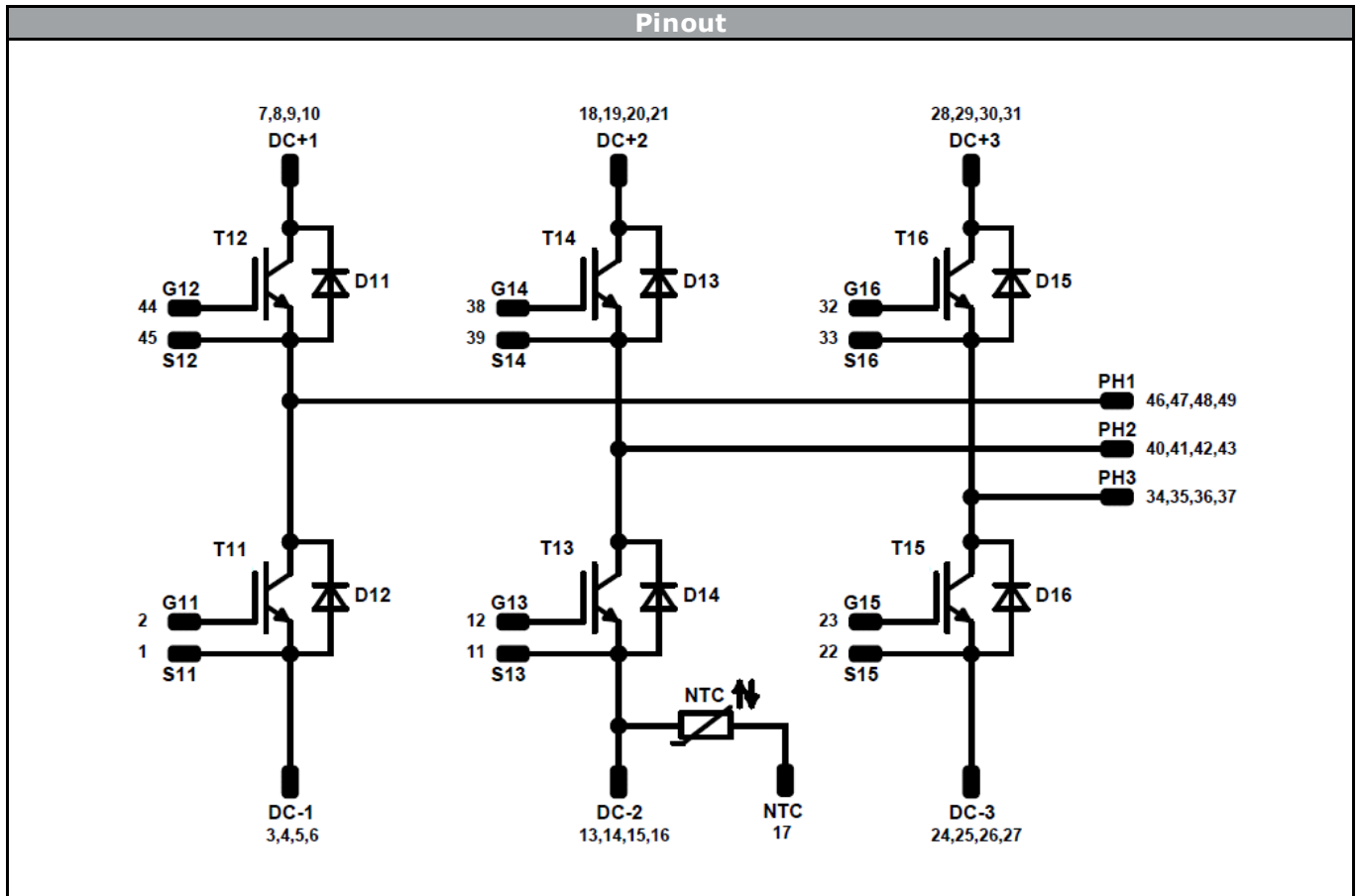
Vincotech

Ordering Code & Marking								
Version				Ordering Code				
with thermal paste 17mm housing with Press-fit pins				30-P2126PA150SC-L280F09Y-/3/				
NN-NNNNNNNNNNNNNN TTTTIVV WWYY UL Vinco LLLLL SSSS		Text	Name	Date code	UL & Vinco	Lot	Serial	
			NN-NNNNNNNNNNNNNN-TTTTIVV	WWYY	UL Vinco	LLLLL	SSSS	
		Datamatrix	Type&Ver	Lot number	Serial	Date code		
		TTTTTIVV	LLLLL	SSSS	WWYY			

Outline							
Pin table [mm]				Pin table [mm]			
Pin	X	Y	Function	Pin	X	Y	Function
1	0,9	0	S11	30	68,5	0	DC+3
2	0,9	3	G11	31	68,5	2,7	DC+3
3	3,9	0	DC-1	32	64,7	36	G16
4	3,9	2,7	DC-1	33	61,7	36	S16
5	3,9	5,4	DC-1	34	58,7	36	PH3
6	6,6	0	DC-1	35	56	36	PH3
7	15,2	0	DC+1	36	53,3	36	PH3
8	15,2	2,7	DC+1	37	50,6	36	PH3
9	17,9	0	DC+1	38	39,4	36	G14
10	17,9	3	DC+1	39	36,4	36	S14
11	26,2	0	S13	40	33,4	36	PH2
12	26,2	2,7	G13	41	30,7	36	PH2
13	29,2	0	DC-2	42	28	36	PH2
14	29,2	2,7	DC-2	43	25,3	36	PH2
15	29,2	5,4	DC-2	44	14,1	36	G12
16	31,9	0	DC-2	45	11,1	36	S12
17	32,2	4,05	NTC	46	8,1	36	PH1
18	40,5	0	DC+2	47	5,4	36	PH1
19	40,5	2,7	DC+2	48	2,7	36	PH1
20	43,2	0	DC+2	49	0	36	PH1
21	43,2	2,7	DC+2				
22	51,5	0	S15				
23	51,5	3	G15				
24	54,5	0	DC-3				
25	54,5	2,7	DC-3				
26	54,5	5,4	DC-3				
27	57,2	0	DC-3				
28	65,8	0	DC+3				
29	65,8	2,7	DC+3				



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Identification					
ID	Component	Voltage	Current	Function	Comment
T11,T12,T13 T14,T15,T16	IGBT	1200 V	150 A	Inverter Switch	
D11,D12,D13 D14,D15,D16	FWD	1200 V	150 A	Inverter Diode	
NTC	NTC			Thermistor	



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Packaging instruction					
Standard packaging quantity (SPQ)	42	>SPQ	Standard	<SPQ	Sample

Handling instruction	
Handling instructions for <i>flow</i> 2 packages see vincotech.com website.	

Package data	
Package data for <i>flow</i> 2 packages see vincotech.com website.	

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As used herein:

1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, or (c) whose failure to perform when properly used in accordance with instructions for use provided in labelling can be reasonably expected to result in significant injury to the user.
2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.